

# BRIDGELUX BLUE POWER DIE

BXCD 17 mil x 34 mil

## PRODUCT DATA SHEET DS-C27

The Bridgelux family of blue power die enables high performance and cost effective solutions to serve solid state lighting market. This next generation chip technology delivers improved efficiency and performance to enable increased light output for a variety of lighting, signaling and display applications.

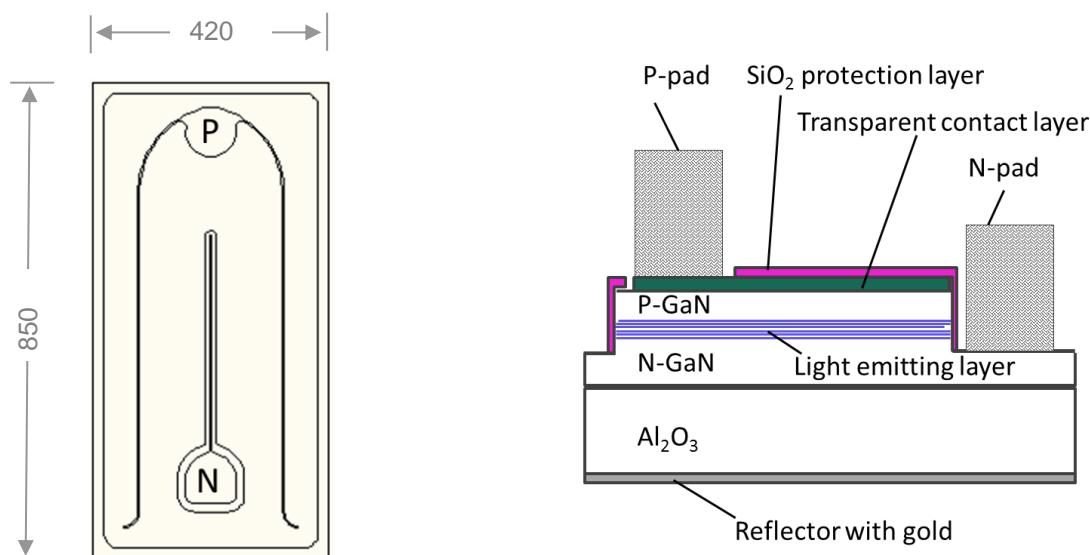
### Features

- High lumen output and efficiency
- Long operating life
- 100% Tested and sorted by wavelength, power and forward voltage
- Lambertian emission pattern
- Compatible with Solder paste, solder preform or silver epoxy die attach
- Delivered on medium tack blue tape (20cm±10mm x20 cm±10mm)

### Applications

- General Illumination
- Portable Lighting
- Architectural Lighting
- Directional Lighting
- Display Backlighting
- Digital Camera Flash
- Automotive Lighting
- White LEDs

### LED Chip Diagram



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## **Product Nomenclature**

**B X C D 1734 X X X – Y – Z**

Where:

- BXCD: Designates product family
- 1734: Designates die size (17 mil x 34 mil)
- XXX: Designates dominant wavelength bin
- Y: Designates radiometric power bin
- Z: Designates forward voltage bin

## **Part Numbering and Bin Definitions**

Bridgelux LED chips are sorted into the brightness and dominant wavelength bins shown below at  $I_f = 120$  mA. Each blue tape contains die from only one brightness bin and one wavelength bin.

The forward voltage bins are 3.0-3.1 V (A1), and 3.1-3.2 V (A2).

<b>Dominant Wavelength</b>	<b>Power Bin C8 (180 – 190 mW)</b>	<b>Power Bin C9 (190 – 200 mW)</b>	<b>Power Bin D1 (200 – 210 mW)</b>
<b>450 to 452.5nm</b>	BXCD1734450-C8-z	BXCD1734450-C9-z	BXCD1734450-D1-z
<b>452.5 to 455nm</b>	BXCD1734452-C8-z	BXCD1734452-C9-z	BXCD1734452-D1-z
<b>455 to 457.5nm</b>	BXCD1734455-C8-z	BXCD1734455-C9-z	BXCD1734455-D1-z
<b>457.5 to 460nm</b>	BXCD1734457-C8-z	BXCD1734457-C9-z	BXCD1734457-D1-z

<b>Dominant Wavelength</b>	<b>Power Bin D2 (210 – 220 mW)</b>
<b>450 to 452.5nm</b>	BXCD1734450-D2-z
<b>452.5 to 455nm</b>	BXCD1734452-D2-z
<b>455 to 457.5nm</b>	BXCD1734455-D2-z
<b>457.5 to 460nm</b>	BXCD1734457-D2-z

**Note:** z = "A1" for Vf bin of 3.0-3.1V; z = "A2" for Vf bin of 3.1-3.2V

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## Mechanical Dimensions

Chip size	420( $\pm 35$ ) $\mu\text{m}$ x 850( $\pm 35$ ) $\mu\text{m}$ (17 mil x 34 mil)
Wafer thickness	130 $\pm$ 10 $\mu\text{m}$ (5.9 mil)
Pad Thickness	3.5 $\pm$ 0.3 $\mu\text{m}$
Pad diameter	P: 80 $\mu\text{m}$ / N: 80 $\mu\text{m}$

## Absolute Maximum Ratings

Parameter	Symbol	Maximum Rating	Condition
Forward DC Current	I <sub>f</sub>	240 mA <sup>1</sup>	T <sub>a</sub> =25°C
Forward Voltage	V <sub>f</sub>	3.3 V	I <sub>f</sub> = 120 mA
Reverse voltage	V <sub>r</sub>	-5V	T <sub>a</sub> =25°C
Reverse Current	I <sub>r</sub>	2.0 $\mu\text{A}$	V <sub>r</sub> = -5 V
Junction Temperature	T <sub>j</sub>	125°C	
Optical Power (minimum)	P <sub>0</sub>	180mW	I <sub>f</sub> = 120 mA
Assembly Process Temp.		325°C for <5 seconds	
Storage Conditions (chip on tape)		0°C to +40°C ambient, RH < 65%	

## Notes:

1. Maximum drive current depends on junction temperature, die attach methods/materials, and lifetime requirements of the application.
2. Bridgelux LED chips are Class 1 ESD sensitive.
3. The typical spectra half-width of the BXCD1734 blue power die is < 25 nm.
4. Please consult the Bridgelux technical support team for information on how to optimize the light output of our chips in your package.
5. Brightness values are measured in an integrating sphere using gold plated TO39 headers without encapsulation.
6. Tapes should be stored in a vertical orientation, not horizontally stacked. Stacking of tapes can place excessive pressure on the bond pads of the LED, resulting in reduced wire bonding strength.

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### **Environmental Compliance**

Bridgelux is committed to providing environmentally friendly products to the solid state lighting market. Bridgelux BXCD1734 blue power die are compliant to the European Union directives on the restriction of hazardous substances in electronic equipment, namely the RoHS directive. Bridgelux will not intentionally add the following restricted materials to BXCD1734 die products: lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) or polybrominated diphenyl ethers (PBDE).

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### Performance vs. Current

The following curves represent typical performance of the BXCD1734 blue power die. Actual performance will vary slightly for different power, dominant wavelength, and Vf bins.

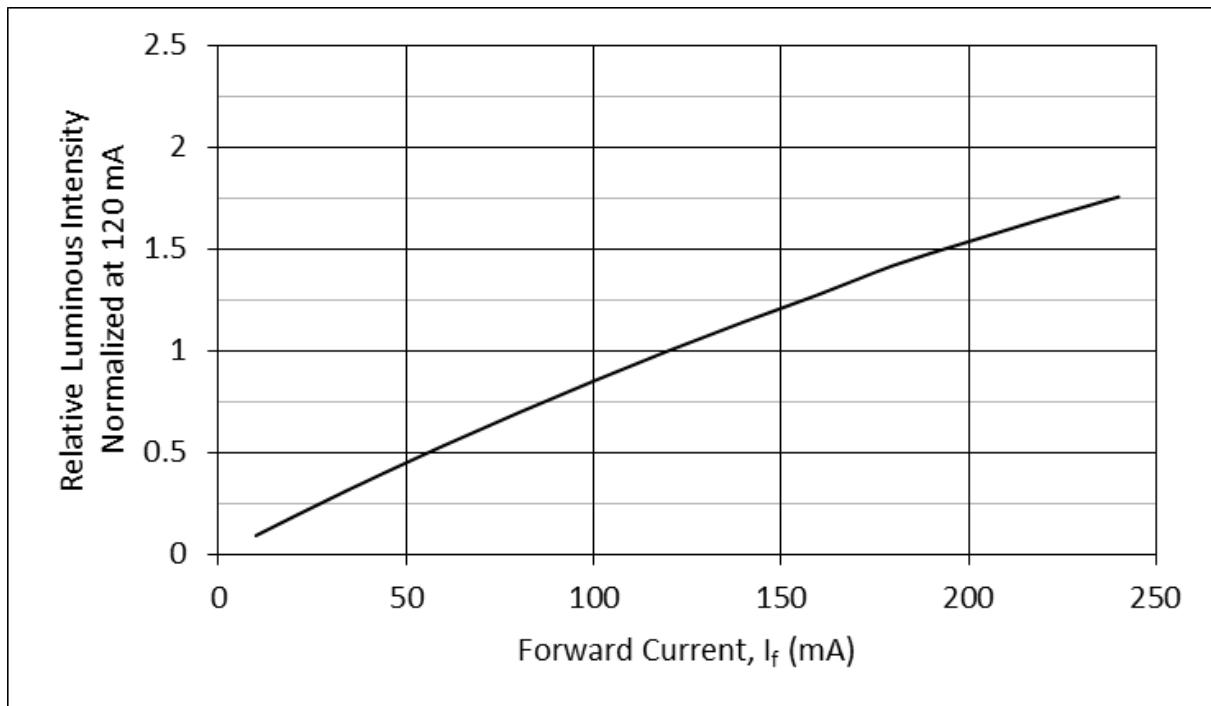


Figure 1: Relative Luminous Intensity vs. Forward Current ( $T_j = 25^\circ\text{C}$ )

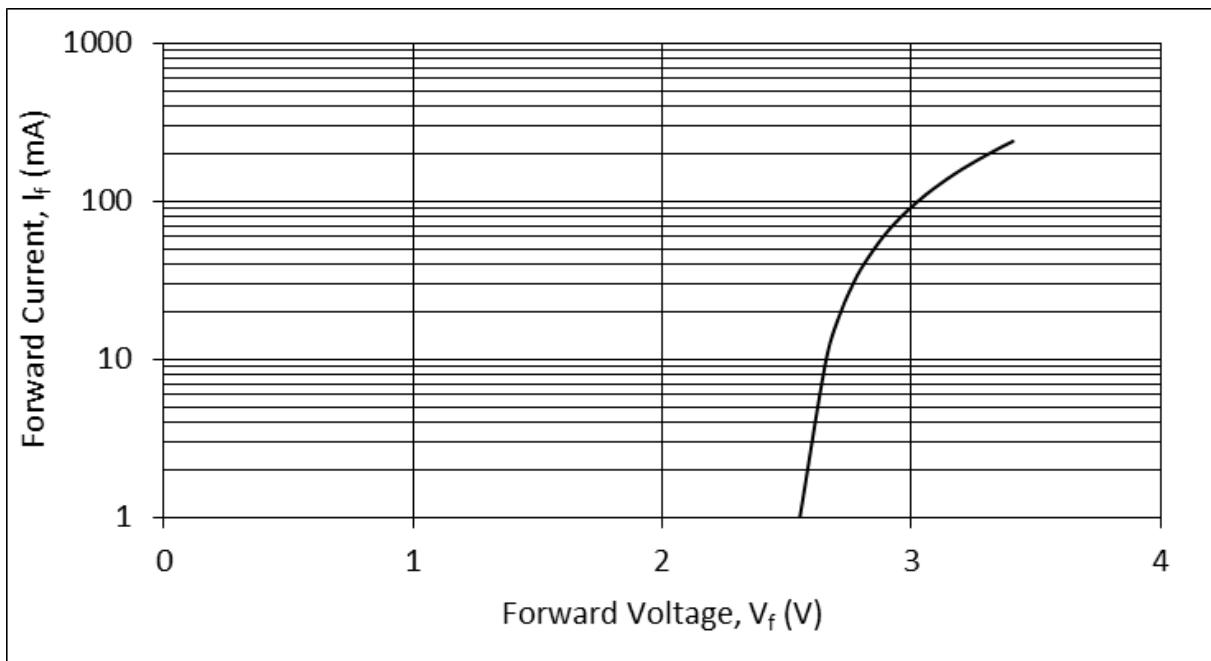


Figure 2: Forward Current vs. Forward Voltage ( $T_j = 25^\circ\text{C}$ )

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### Performance vs. Junction Temperature

The following curves represent typical performance of the BXCD1734 blue power die. Actual performance will vary slightly for different power, dominant wavelength, and Vf bins.

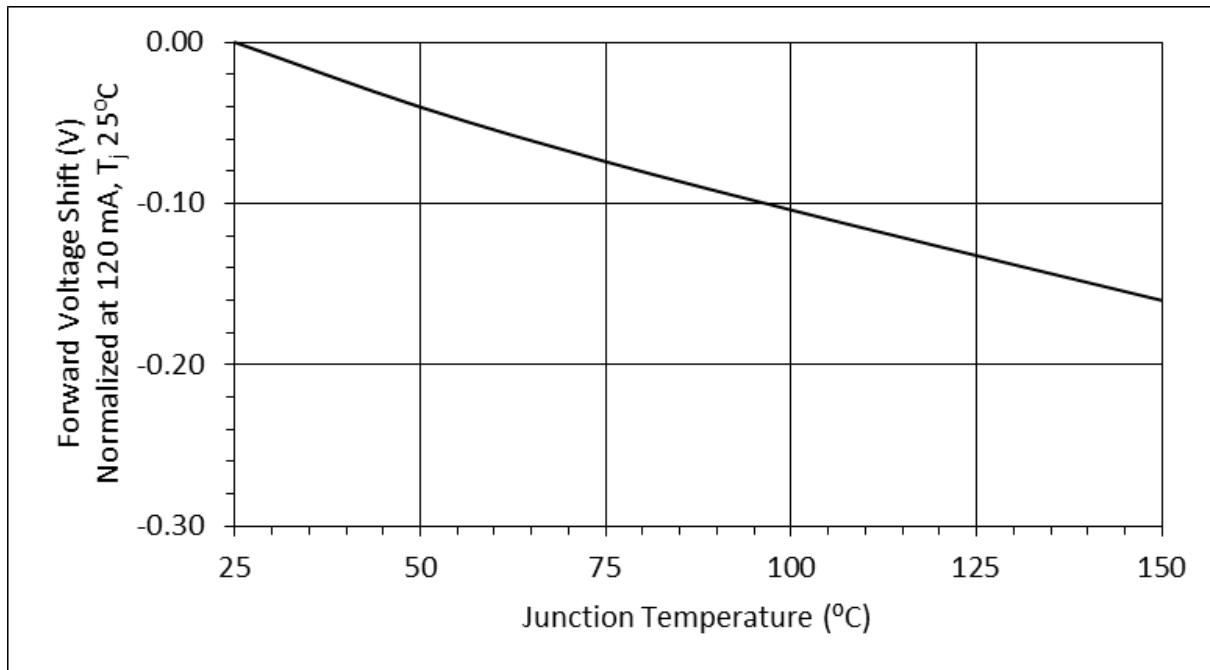


Figure 3: Forward Voltage Shift vs. Junction Temperature

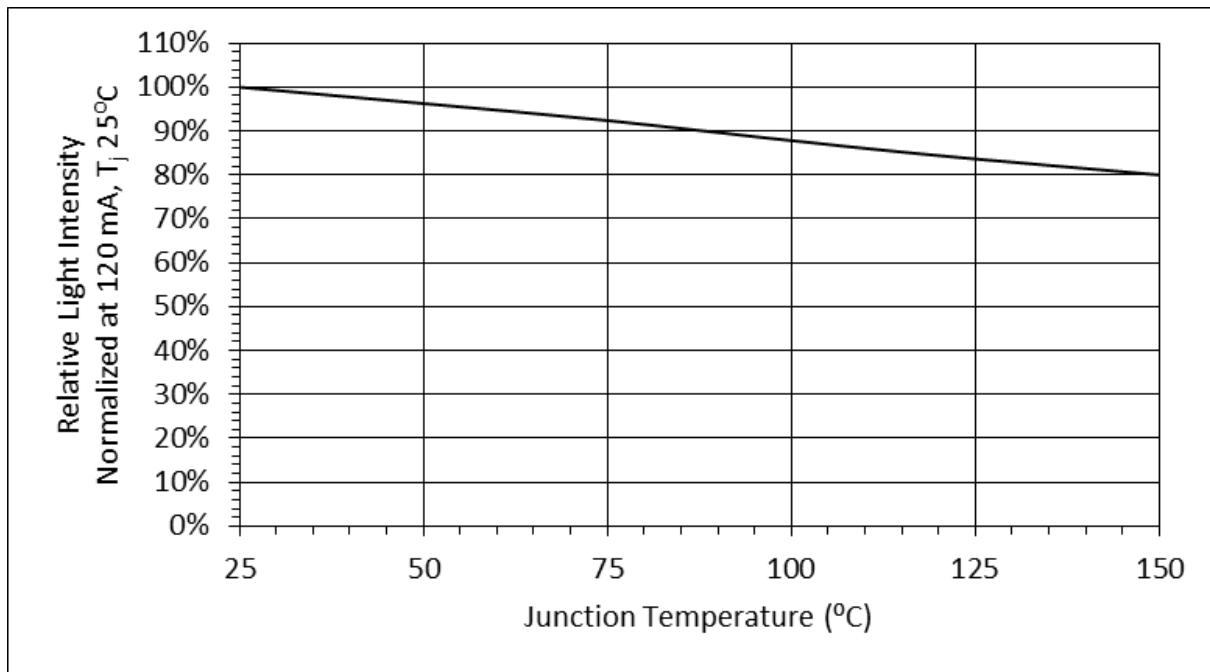


Figure 4: Relative Light Intensity vs. Junction Temperature

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### Wavelength Shift

The following curves represent typical performance of the BXCD1734 blue power die. Actual performance will vary slightly for different power, dominant wavelength, and Vf bins.

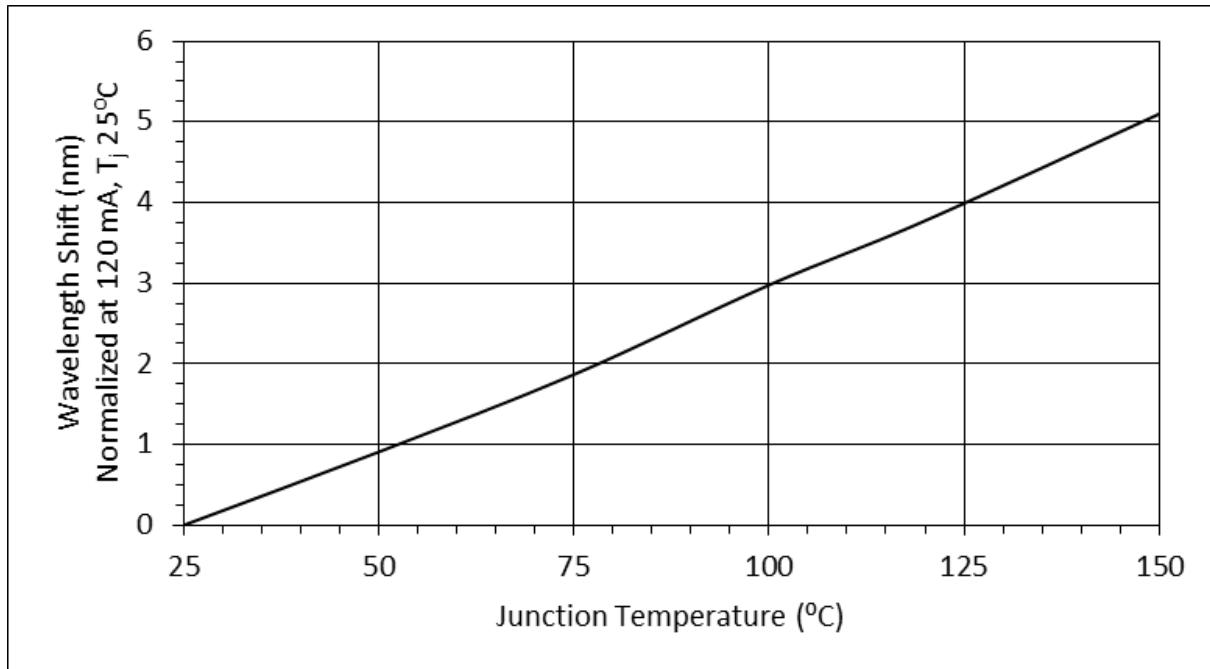


Figure 5: Wavelength Shift vs. Junction Temperature

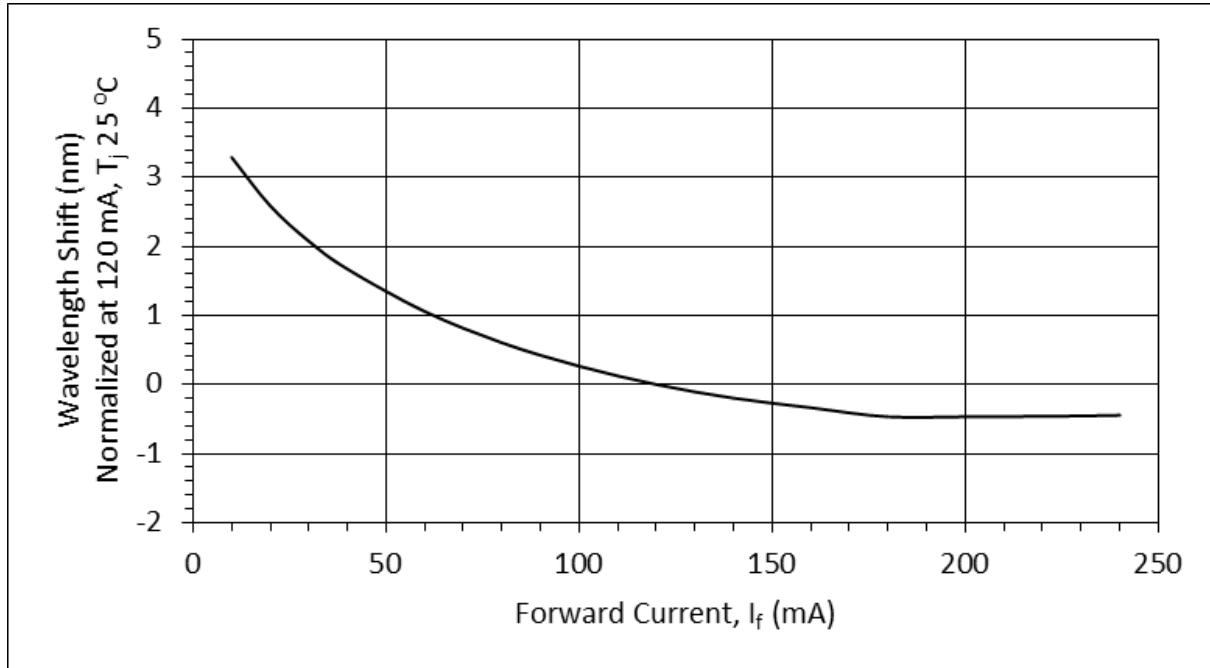


Figure 6: Wavelength Shift vs. Forward Current

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### Typical Radiation Pattern

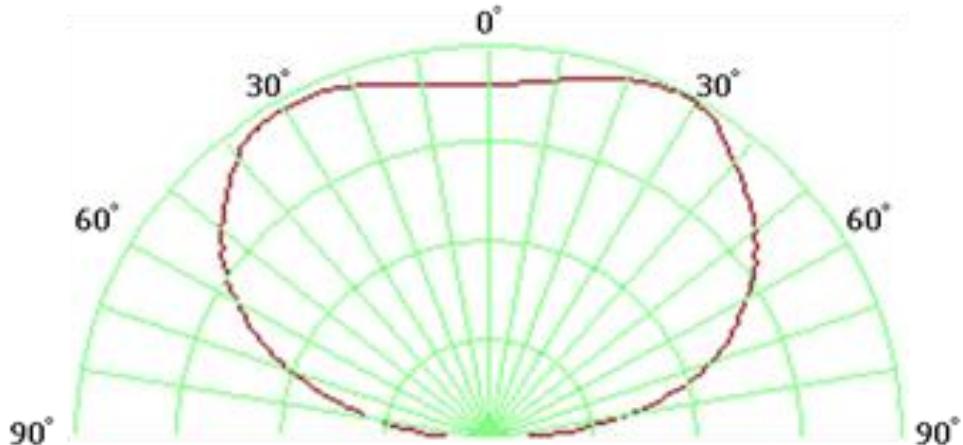


Figure 7: Typical Radiation Pattern (120 mA Operation)

### Current De-rating Curves

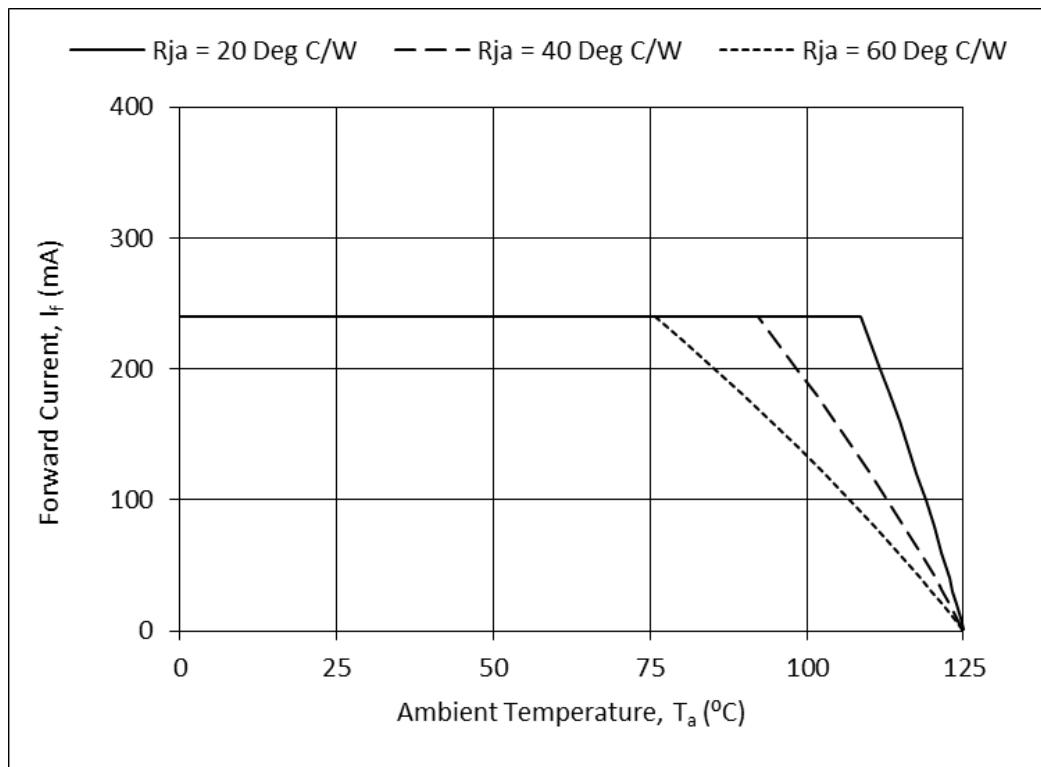


Figure 8: Current Derating Curve vs. Ambient Temperature (derating based on  $T_j$  max  $125^{\circ}\text{C}$ )

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### **About Bridgelux**

Bridgelux is a leading developer and manufacturer of technologies and solutions transforming the \$40 billion global lighting industry into a \$100 billion market opportunity. Based in Livermore, California, Bridgelux is a pioneer in solid state lighting (SSL), expanding the market for light emitting diode (LED) technologies by driving down the cost of LED lighting systems. Bridgelux's patented light source technology replaces traditional technologies (such as incandescent, halogen, fluorescent and high intensity discharge lighting) with integrated, solid state lighting solutions that enable lamp and luminaire manufacturers to provide high performance and energy-efficient white light for the rapidly growing interior and exterior lighting markets, including street lights, commercial lighting and consumer applications. Bridgelux is the only vertically integrated LED manufacturer and developer of solid-state light sources that designs its solutions specifically for the lighting industry.

For more information about the company, please visit [www.bridgelux.com](http://www.bridgelux.com)

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